

**PATENT**

Docket No.:JCLA8104-D

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of :

Applicant : PHILLIP CHUNG-HWEI CHEN et al.

Filed : Herewith

For : LOW-MELTING-TEMPERATURE TIN AND PLATING PROCESS

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**PRELIMINARY AMENDMENT**

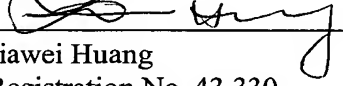
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Prior to the examination on merits, please amend the above-identified application as shown in the attached sheets. No new matter has added through the amendment. Entry of the amendment is requested.

Respectfully submitted,

Dated: 10/31/2003

By:   
Jiawei Huang  
Registration No. 43,330

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